

Docket: 740819-1016
Application No. 10/600,596
Page 2

AMENDMENT TO THE SPECIFICATION

Please replace the paragraph beginning at page 9, line 5, with the following paragraph:

-- FIG. 11A and 11B are cross-sectional view schematically showing two types of lamp heating systems for a thermal treatment in a method for evaluating the lamp heating systems accordance with the second embodiment. --

Please replace the paragraph beginning at page 21, line 24, with the following paragraph:

-- First, in the first step **STP1** shown in FIG.10, a first set of first and second wafers **10A** and **10B** is loaded into each chamber 3 of a first and second lamp heating system **21** or **22** as shown in FIG. 11A and 11B. At this time, the second semiconductor layers **11b** of the first and second wafers **10A** and **10B** for the first set are supposed to have thicknesses of 44nm and 41nm, respectively. --